

#### **General Description**

The MAX9483/MAX9484 high-performance, multimode, laser-diode drivers (LDDs) are designed for CD and DVD combination pickup heads. The drivers consist of three input channels, an RF oscillator, and two precision current-amplifier outputs to drive the CD and DVD laser diodes. The MAX9483/MAX9484 support multiple CD and DVD read/write standards, such as CD-R/RW, DVD-R, DVD+R, DVD-RW, DVD+RW, and DVD-RAM by choosing the writing control signals and input currents on these input channels. The peak total output current is 400mA with a current gain of 100 at each channel. External resistors set the oscillation frequency and output swing. The MAX9484 features an extra resistor input allowing the oscillation frequencies of the two outputs to be set separately. Additionally, the MAX9484 allows the writing control signals to be received in lowvoltage differential signal (LVDS) mode or single-ended mode to provide reliable high-speed writing.

The MAX9483 is offered in 16-pin QSOP and 4mm x 4mm 16-pin thin QFN packages. The MAX9484 is offered in a 4mm x 4mm 20-pin thin QFN package. Both devices are specified for 4.5V to 5.5V supply and 0°C to +70°C temperature range.

#### **Applications**

Laser Diode Driver for CD-RW and DVD Combos: CD-R/RW, DVD-R, DVD+R, DVD-RW, DVD+RW, DVD-RAM

**DVD Video Recorders** 

High-Power and High-Speed Laser-Writable **Device Drivers** 

#### **Features**

- **♦ Dual Output Ports with Three Controlled-Current Channels**
- **♦** Support Various Laser-Diode Driver Standards CD-R/RW, DVD-R, DVD+R, DVD-RW, DVD+RW, DVD-RAM, and DVD Video
- ♦ MAX9483 is Pin and Function Compatible with ATMEL T0806
- ♦ Independent Frequency Setting for the **Two Output Ports (MAX9484)**
- **♦** Accepts Differential (LVDS) or Single-Ended Inputs for Writing Data (MAX9484)
- **♦ Enable Control**
- ♦ High-Current Swing Up to 270mA for the Reading Current
- ♦ High 400mA Total Peak Writing Current
- ♦ Adjustable Modulation Frequency from 100MHz to 600MHz
- ♦ Fast Output-Current Pulse Rise and Fall Time 1.0ns (typ)
- ♦ 4.5V to 5.5V Single-Supply Voltage
- ♦ No External Reference Clock Required
- ♦ 0°C to +70°C Commercial Temperature Range

#### **Pin Configurations**

#### TOP VIEW IN1 1 16 V<sub>CC</sub> 15 OUT1 IN2 2 IN3 3 GND MIXIM R<sub>F</sub> 4 MAX9483 13 R<sub>S1</sub> NE2 5 12 R<sub>S2</sub> 11 OUT2 NE3 6 ENABLE 7 10 OUTSEL ENOSC 8 Vcc **QSOP** Pin Configurations continued at end of data sheet.

#### **Ordering Information**

PART	TEMP RANGE	PIN-PACKAGE
MAX9483CEE	0°C to +70°C	16 QSOP
MAX9483CTE*	0°C to +70°C	16 Thin QFN
MAX9484CTP	0°C to +70°C	20 Thin QFN

<sup>\*</sup>Future product—contact factory for availability.

#### **ABSOLUTE MAXIMUM RATINGS**

V <sub>CC</sub> , V <sub>CCO</sub> to GND0.3V to +6.0V	Junction Temperature+150°C
IN_, RF_, RS_ to GND0.3V to (V <sub>CC</sub> + 0.3V)	Storage Temperature Range65°C to +150°C
ENABLE, ENOSC, NE2_, NE3_,	ESD Rating (Human Body Model)≥ ±2.0kV
OUTSEL to GND0.3V to (V <sub>CC</sub> + 0.3V)	Lead Temperature (soldering, 10s)+300°C
Output Voltage at OUT1, OUT20.3V to (V <sub>CC</sub> - 1V)	
Continuous Power Dissipation (TA = +70°C)	
QSOP (derate 8.3mW/°C above +70°C)667mW	
TQFN (derate 16.9mW/°C above +70°C)1349mW	

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

#### DC ELECTRICAL CHARACTERISTICS

 $(V_{CC} = V_{CCO} = +4.5V \text{ to } +5.5V, R_L = 6.8\Omega, ENABLE = high, NE2 = NE3 = high (MAX9483), NE2_ = NE3_ = differential high (MAX9484), ENOSC = low, T_A = 0°C to +70°C, unless otherwise noted. Typical values are at <math>V_{CC} = V_{CCO} = +5V$ ,  $T_A = +25$ °C.) (Notes 1, 2, 4)

PARAMETER	SYMBOL	CONDITIONS	}	MIN	TYP	MAX	UNITS
POWER SUPPLY				•			
Write Made Supply Current	lee	$I_{IN1} = I_{IN2} = I_{IN3} = 500 \mu A,$	MAX9483		181	200	mA
Write-Mode Supply Current	ICC1	NE2 = NE3 = low	MAX9484		182	210	MA
		Oscillator enabled, I <sub>IN1</sub> = I <sub>IN2</sub> = I <sub>IN3</sub> = 500µA,	MAX9483		91	100	
Read-Mode Supply Current	I <sub>CC2</sub>	ENOSC = high, R <sub>S</sub> = $8.2k\Omega$ , R <sub>F</sub> = $6.8k\Omega$	MAX9484		92	105	mA
		Oscillator disabled,	MAX9483		82	95	
		$I_{IN1} = I_{IN2} = I_{IN3} = 500 \mu A$	MAX9484		83	95	
Supply Current	loos	Input disabled,	MAX9483		14	20	mΛ
Supply Current	ICC3	$I_{1N1} = I_{1N2} = I_{1N3} = 0$	MAX9484		14	20	mA
Power-Down Supply Current	I <sub>CC4</sub>	ENABLE = NE2 = NE3 = low,	MAX9483		0.96	2.0	mA
Tower-bown Supply Current		$I_{1N1} = I_{1N2} = I_{1N3} = 0$	MAX9484		1.2	2.0	1117 (
DIGITAL INPUTS FOR WRITE C	HANNEL CO	ONTROL (NE2, NE3) (MAX9483	)				
High-Level Input Voltage	V <sub>IH1</sub>			2.0			V
Low-Level Input Voltage	V <sub>IL1</sub>					0.8	V
Input Current	l <sub>IN1</sub>	V <sub>IN</sub> = high or low		-20		+20	μΑ
LVDS DIGITAL INPUTS FOR WE	RITE CHANN	IEL CONTROL (NE2_, NE3_) (N	MAX9484)				
Differential Input High Threshold	V <sub>TH</sub>					50	mV
Differential Input Low Threshold	$V_{TL}$			-50			mV
SINGLE-ENDED DIGITAL INPUT	S FOR WRI	TE CHANNEL CONTROL (NE2	+, NE3+) (MAX9	484)			
Reference Voltage	V <sub>REF</sub>			1.10	1.25	1.40	V
High-Level Input Voltage	V <sub>IH2</sub>			V <sub>REF</sub> + 300			mV
Low-Level Input Voltage	V <sub>IL2</sub>					V <sub>REF</sub> - 300	mV
Input Current	I <sub>IN2</sub>	V <sub>IN</sub> = high or low		-20		+20	μΑ

\_ /N/XI/N

#### DC ELECTRICAL CHARACTERISTICS (continued)

 $(V_{CC} = V_{CCO} = +4.5V \text{ to } +5.5V, R_L = 6.8Ω, ENABLE = high, NE2 = NE3 = high (MAX9483), NE2_ = NE3_ = differential high (MAX9484), ENOSC = low, T<sub>A</sub> = 0°C to +70°C, unless otherwise noted. Typical values are at <math>V_{CC} = V_{CCO} = +5V$ , T<sub>A</sub> = +25°C.) (Notes 1, 2, 4)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
DIGITAL INPUTS FOR CONTROL	SIGNALS	(ENABLE, OUTSEL, ENOSC)	•			
High-Level Input Voltage	V <sub>IH3</sub>		2.0			V
Low-Level Input Voltage	V <sub>IL3</sub>				0.8	V
Input Current	I <sub>IN3</sub>	V <sub>IN</sub> = high or low	-10		+10	μΑ
ANALOG INPUTS (IN1, IN2, IN3)						
Current Channel Input Current Range	ICIN	Current flowing into IN1, IN2, or IN3	0		4.0	mA
Current Channel Input Impedance	R <sub>IN</sub>	IN_ to GND	165	200	235	Ω
OUTPUTS (OUT1 and OUT2)			•			
Maximum Total Output Current	lout		320	400		mA
Maximum Output Current per	lou-	Read current IN1	210	273		m 1
Channel	lout	Write current IN2, IN3	250	347		- mA
Best-Fit Current Gain	Aı	Any channel (Note 3)		100		I/I
Best-Fit Current Offset	IOFFSET	Any channel (Note 3)	-4		+4	mA
Output Current Linearity		Any channel (Note 3)	-3		+3	%
	IOFF1	ENABLE = low		0.2	1	
Output Off Current	l <sub>OFF2</sub>	NE2 = NE3 = high, $I_{IN1} = 0\mu A$ , $I_{IN2} = I_{IN3} = 500\mu A$		0.22	1.5	mA
	I <sub>OFF3</sub>	$NE2 = NE3 = low, I_{IN1} = I_{IN2} = I_{IN3} = 0\mu A$		0.14	5	
Read-Mode Output Supply Sensitivity		I <sub>OUT</sub> = 40mA	-2		+2	%/V
Write-Mode Output Supply Sensitivity		I <sub>OUT</sub> = 80mA	-2		+2	%/V
Read-Mode Output Temperature Sensitivity		I <sub>OUT</sub> = 40mA		15		ppm°C
Write-Mode Output Temperature Sensitivity		I <sub>OUT</sub> = 80mA		16	_	ppm°C
Output Noise		I <sub>OUT</sub> = 40mA, ENOSC = low		3		nA/√Hz
	l	I .				

#### **AC ELECTRICAL CHARACTERISTICS**

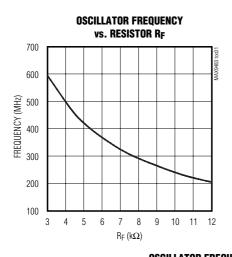
 $(V_{CC} = V_{CCO} = +4.5V \text{ to } +5.5V, I_{OUT} = 40\text{mA} \text{ (read)} + 40\text{mA}, R_L = 6.8\Omega, ENABLE = high, NE2 = NE3 = high (MAX9483), NE2 = NE3 = differential high (MAX9484), ENOSC = low, T_A = 0°C to +70°C, unless otherwise noted. Typical values are at <math>V_{CC} = V_{CCO} = +5V$ ,  $V_{CC} = +5V$ , V

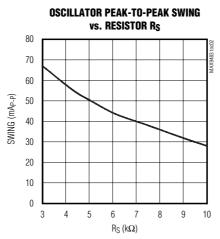
PARAMETER SYMBOL CONDI		CONDITIONS	MIN	TYP	MAX	UNITS
OSCILLATOR	•			•		
Oscillator Frequency	fosc	$R_{F_{-}} = 7.5k\Omega$ (Note 2), $I_{OUT} = 40mA$ (read)	255	300	350	MHz
Oscillator Temperature Coefficient		$R_{F_{-}} = 7.5 k\Omega$		10		ppm/°C
OUTPUT TIMING						
Write Rise Time	t <sub>r</sub>	I <sub>OUT</sub> = 40mA (read) + 40mA (10% to 90%)		0.9	1.6	ns
Write Fall Time	t <sub>f</sub>	I <sub>OUT</sub> = 40mA (read) + 40mA (90% to 10%)		1.0	1.6	ns
Output-Current Overshoot	000			5		%
Output ON Propagation Delay	ton	NE 50% high-low to IOUT at 50% of final value		1.0	2.0	ns
Output OFF Propagation Delay	toff	NE 50% low-high to IOUT at 50% of final value		1.0	2.0	ns
Output Disable Time	tDIS	ENABLE 50% high-low to I <sub>OUT</sub> at 50% of final value at I <sub>OUT</sub> = 40mA (read)		60	100	ns
Output Enable Time	t <sub>EN</sub>	ENABLE 50% low-high to I <sub>OUT</sub> at 50% of final value at I <sub>OUT</sub> = 40mA (read)		60	100	ns
Oscillator Disable Time	tDISO	ENOSC 50% high-low to IOUT at 50% of final value at IOUT = 40mA (read)		4	10	ns
Oscillator Enable Time	t <sub>EHO</sub>	ENOSC 50% high-low to IOUT at 50% of final value at IOUT = 40mA (read)		25	50	ns
Channel Select Delay	todh	OUTSEL 50% low-high to I <sub>OUT</sub> at 50% of final value measured at OUT1		2.9	10	200
Channel-Select Delay	t <sub>ODL</sub>	OUTSEL 50% high-low to IOUT at 50% of final value measured at OUT2		2.9	10	ns

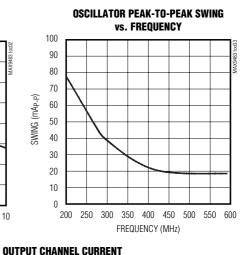
- Note 1: Current into a pin is defined as positive. Current out of a pin is defined as negative. All voltages are referenced to ground except V<sub>TH</sub>.
- Note 2: Maximum and minimum limits over temperature are guaranteed by design and characterization. Devices are production tested at T<sub>A</sub> = +25°C.
- Note 3: Linearity of the amplifier is calculated using a best-fit method at three operating points of I<sub>OUT</sub> at 20mA, 40mA, and 60mA. I<sub>OUT</sub> = (I<sub>IN</sub> × GAIN) + I<sub>OFFSET</sub>.
- Note 4: Guaranteed by design and characterization. Limit set at ±6 sigma.

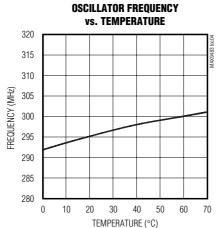
#### **Typical Operating Characteristics**

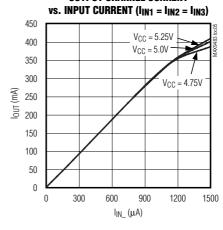
 $(VCC = VCCO_ = +5V, TA = +25^{\circ}C, unless otherwise noted.)$ 

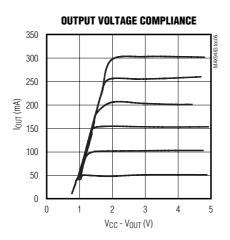


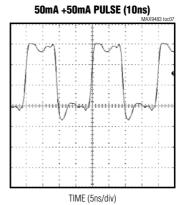












### **Pin Description**

PIN							
MAX9483 MAX9484		MAX9484	NAME	FUNCTION			
QSOP	TQFN	TQFN					
1	15	18	IN1	Channel 1 Input Current (Read Channel)			
2	16	19	IN2	Channel 2 Input Current (Write Channel)			
3	1	20	IN3	Channel 3 Input Current (Write Channel)			
4	2	_	RF	Oscillator Frequency-Setting Resistor. Connect an external resistor to GND to set the frequency of the oscillator for both outputs OUT1 and OUT2.			
5	3	_	NE2	Channel 2 Active-Low Digital Control Input			
6	4	_	NE3	Channel 3 Active-Low Digital Control Input			
7	5	8	ENABLE	LVTTL Output-Current Enable			
8	6	9	ENOSC	LVTTL Oscillator Enable			
9, 16	14	17	V <sub>C</sub> C	+5V Power Supply. Bypass to GND with 0.1µF and 0.01µF capacitors with the 0.01µF capacitor as close to the pin as possible.			
10	8	11	OUTSEL	LVTTL Output Select. Drive high to select output 1; pull low to select output 2.			
11	9	12	OUT2	Output Current 2			
12	10	13	R <sub>S2</sub>	Output 2 Oscillator Current Swing-Setting Resistor. Connect an external resistor to GND to set the swing current of output port 2.			
13	11	14	R <sub>S1</sub>	Output 1 Oscillator Current Swing-Setting Resistor. Connect an external resistor to GND to set the swing current of output port 1.			
14	_	_	GND	Ground			
15	12	15	OUT1	Output Current 1			
_	_	1	R <sub>F1</sub>	Output 1 Oscillator Frequency-Setting Resistor. Connect an external resistor to GND to set the frequency of the oscillator for OUT1.			
_	_	2	R <sub>F2</sub>	Output 2 Oscillator Frequency-Setting Resistor. Connect an external resistor to GND to set the frequency of the oscillator for OUT2.			
_	_	3	NE2+	Noninverting Channel 2 LVDS or Single-Ended Digital Control Input			
_	_	4	NE2-	Inverting Channel 2 LVDS or Reference for Single-Ended Digital Control Input			
_	_	6	NE3+	Noninverting Channel 3 LVDS or Single-Ended Control Digital Input			
_	_	7	NE3-	Inverting Channel 3 LVDS or Reference for Single-Ended Control Digital Input			
_	7	10	V <sub>CCO2</sub>	+5V Power Supply for Output 2. Bypass to GND with 0.1µF and 0.01µF capacitors with the 0.01µF capacitor as close to pin as possible.			
_	13	16	V <sub>CCO1</sub>	+5V Power Supply for Output 2. Bypass to GND with 0.1µF and 0.01µF capacitors with the 0.01µF capacitor as close to the pin as possible.			
_	_	5	REF	Reference Voltage for Single-Ended Input. Connect a 0.1µF decoupling capacitor to ground.			
_	EP	EP	EP	Exposed Pad. Connect to ground.			

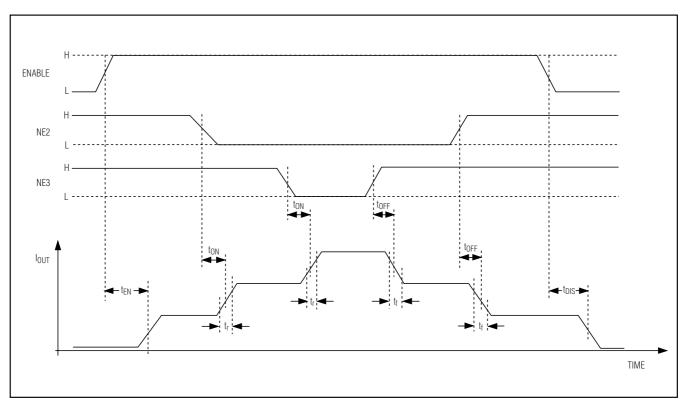


Figure 1. Timing Diagram of Output vs. Control Signals

#### **Detailed Description**

#### **Read Channel and Write Channels**

The MAX9483/MAX9484 high-performance multimode LDDs are designed for CD and DVD combination pickup heads. The drivers have three current channels. Each channel has a current input IN\_ (\_ = 1, 2, or 3) and a channel control signal (ENABLE, NE2, or NE3). IN1 supplies the reference for the read channel, which provides the read current or the offset current to the lasers. The other two channels are the write channels. The currents of these two channels are superimposed on the read current that serves as the offset current for the laser in write mode. The offset current significantly reduces the laser output ramp-up time. When ENABLE is low, all three channels are disabled. Driving ENABLE high enables the read channel and leaves the other two write channels to be controlled by NE2 and NE3 (see Figure 1). By selecting the input currents at IN2 and

IN3, as well as the signal timing of NE2 and NE3, the drivers can generate various current waveforms for different CD/DVD writing standards. All three channels have a current gain of 100. The maximum total current each output can provide is 400mA.

#### **RF** Oscillator

To reduce the laser-mode hopping noise in read mode, modulate the read current with an oscillator with a 100MHz to 600MHz frequency. An external resistor, RF, determines the oscillator frequency selection. For the MAX9484, two external resistors, RF1 and RF2, are used to select the oscillator frequency for CD and DVD lasers separately. The swing amplitude of the oscillator current is set by two external resistors, RS1 and RS2, one for CD and one for DVD. The oscillator is enabled when both ENABLE and ENOSC are driven high.

#### \_Applications Information

#### **LVDS Inputs for MAX9484**

The MAX9484 input control signals, NE2\_ and NE3\_, are compatible with LVDS or single-ended inputs. The LVDS inputs allow the driver to handle higher data writing rates. When using single-ended input signals, such as LVTTL or SSTL\_2, connect NE2- and NE3- to REF.

#### Laser Safety and IEC 825

Using the MAX9483/MAX9484 laser drivers alone does not ensure that a transmitter design is compliant with IEC 825. The entire transmitter circuit and component selections must be considered. Customers must determine the level of fault tolerance required by their application. Note that Maxim products are not designed or authorized for use as components in systems intended for surgical implantation into the body, for applications intended to support or sustain life, or for any other application where the failure of a Maxim product could create a situation where personal injury or death may occur.

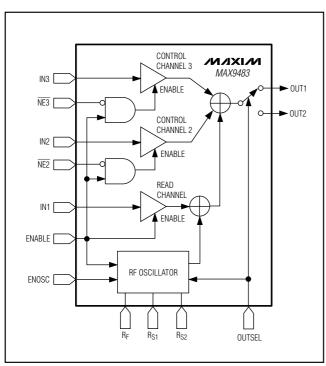


Figure 2. MAX9483 Functional Diagram

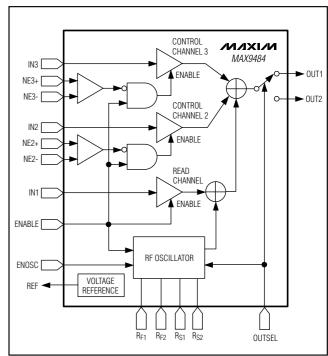


Figure 3. MAX9484 Functional Diagram

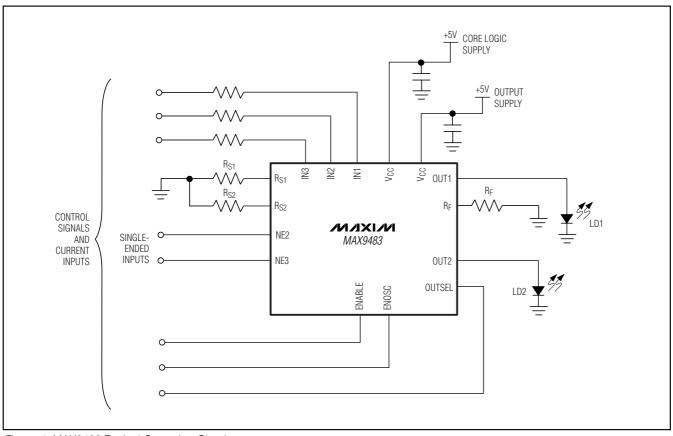


Figure 4. MAX9483 Typical Operating Circuit

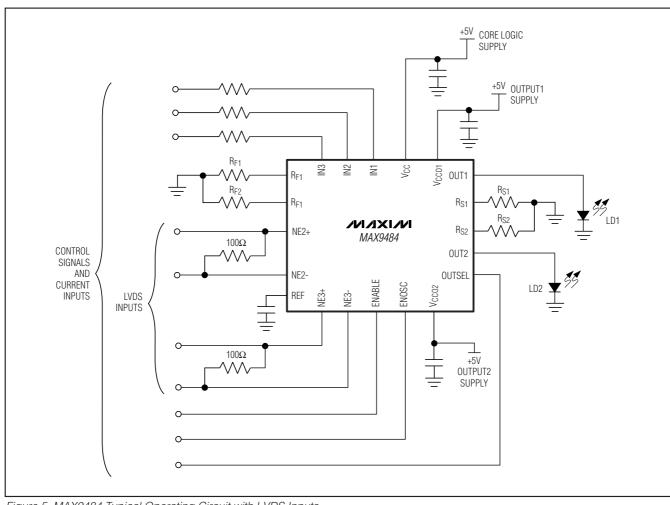


Figure 5. MAX9484 Typical Operating Circuit with LVDS Inputs

10 \_\_\_\_\_\_\_/VIXI/VI

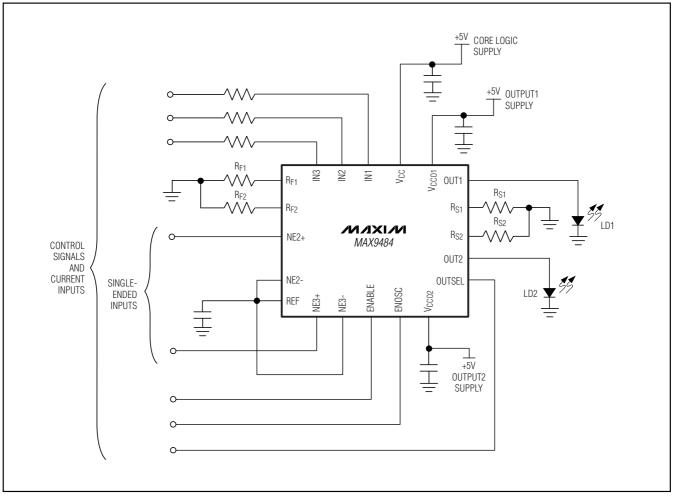
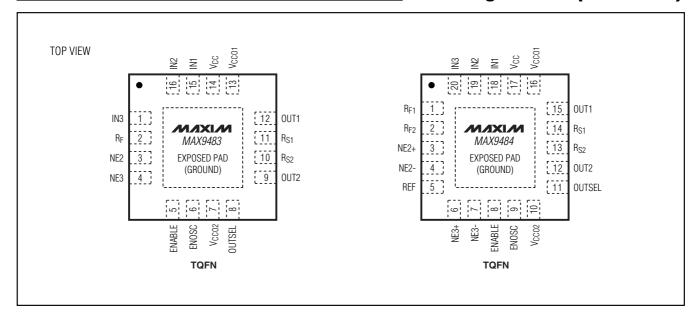


Figure 6. MAX9484 Typical Operation Circuit with Single-Ended Inputs

### Pin Configurations (continued)

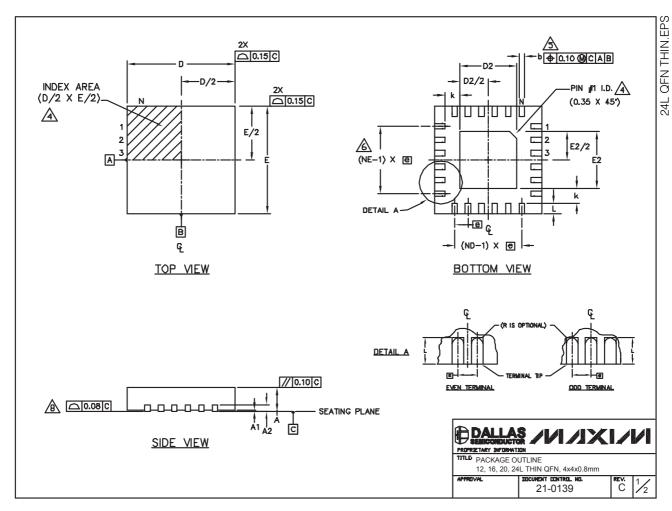


**Chip Information** 

**TRANSISTOR COUNT: 1399** 

#### Package Information

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to <a href="https://www.maxim-ic.com/packages">www.maxim-ic.com/packages</a>.)



#### Package Information (continued)

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to <a href="https://www.maxim-ic.com/packages">www.maxim-ic.com/packages</a>.)

	COMMON DIMENSIONS											
PKG	12	2L 4×	4	16	16L 4×4		20	20L 4×4		24L 4×4		
REF.	MIN.	NDM.	MAX	MIN.	NDM.	MAX.	MIN.	NDM.	MAX	MIN.	NDM.	MAX
Α	0.70	0.75	0.80	0.70	0.75	0.80	0.70	0.75	0.80	0.70	0.75	0.80
A1	0.0	0.02	0.05	0.0	0.02	0.05	0.0	20.0	0.05	0.0	0.02	0.05
A2	0	.20 RE	F	0.20 REF		0	.20 RE	F	0.20 REF			
b	0.25	0.30	0.35	0.25	0.30	0.35	0.20	0.25	0.30	0.18	0.23	0.30
D	3.90	4.00	4.10	3.90	4.00	4.10	3.90	4.00	4.10	3.90	4.00	4.10
Ε	3.90	4.00	4.10	3.90	4.00	4.10	3.90	4.00	4.10	3.90	4.00	4.10
6	(	0.80 BS	C.	0.65 BSC.		0.50 BSC.		0.50 BSC.				
k	0.25	-	-	0.25	-	ı	0.25	ı	ı	0.25	ı	ı
L	0.45	0.55	0.65	0.45	0.55	0.65	0.45	0.55	0.65	0.30	0.40	0.50
N		12			16		20			24		
ND	3			4		5			6			
NE	3			4 5			6					
Jedec Var.		WGGB			WGGC		VGGD-1		1	WGGD-2		

EXPOSED PAD VARIATIONS									
PKG.		D2			E2		DOWN		
CODES	MIN.	NDM.	MAX	MIN.	NOM.	MAX.	ALLOVED		
T1244-2	1.95	2.10	2.25	1.95	2.10	2.25	NO		
T1244-3	1.95	2.10	2.25	1.95	2.10	2,25	YES		
T1244-4	1.95	2.10	2.25	1.95	2.10	2.25	NO		
T1644-2	1.95	2.10	2.25	1.95	2.10	2,25	NO		
T1644-3	1.95	2.10	2.25	1.95	2.10	2.25	YES		
T1644-4	1.95	2.10	2.25	1.95	2.10	2,25	ND		
T2044-1	1.95	2.10	2.25	1.95	2.10	2.25	ND		
T2044-2	1.95	2.10	2.25	1.95	2.10	2,25	YES		
T2044-3	1.95	2.10	2.25	1.95	2.10	2.25	NO		
T2444-1	2.45	2.60	2.63	2.45	2.60	2.63	NO		
T2444-2	1.95	2.10	2.25	1.95	2.10	2.25	YES		
T2444-3	2.45	2.60	2.63	2.45	2.60	2.63	YES		
T2444-4	2.45	2.60	2.63	2.45	2.60	2.63	NO		

#### NOTES:

- 1. DIMENSIONING & TOLERANCING CONFORM TO ASME Y14.5M-1994.
- 2. ALL DIMENSIONS ARE IN MILLIMETERS. ANGLES ARE IN DEGREES.
- 3. N IS THE TOTAL NUMBER OF TERMINALS.
- THE TERMINAL #1 IDENTIFIER AND TERMINAL NUMBERING CONVENTION SHALL CONFORM TO JESD 95-1 SPP-012. DETAILS OF TERMINAL #1 IDENTIFIER ARE OPTIONAL, BUT MUST BE LOCATED WITHIN THE ZONE INDICATED. THE TERMINAL #1 IDENTIFIER MAY BE EITHER A MOLD OR MARKED FEATURE.
- DIMENSION 6 APPLIES TO METALLIZED TERMINAL AND IS MEASURED BETWEEN 0.25 mm AND 0.30 mm FROM TERMINAL TIP.
- 6 ND AND NE REFER TO THE NUMBER OF TERMINALS ON EACH D AND E SIDE RESPECTIVELY.
- 7. DEPOPULATION IS POSSIBLE IN A SYMMETRICAL FASHION.
- & COPLANARITY APPLIES TO THE EXPOSED HEAT SINK SLUG AS WELL AS THE TERMINALS.
- 9. DRAWING CONFORMS TO JEDEC MO220, EXCEPT FOR T2444-1, T2444-3 AND T2444-4.



12, 16, 20, 24L THIN QFN, 4x4x0.8mm

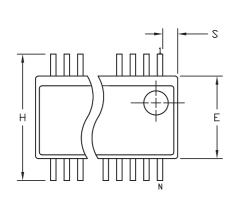
DOCUMENT DINTROL NO. C 2/2

QSOP.EPS

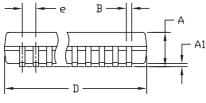
### **Dual-Output, Multimode** CD-RW/DVD Laser-Diode Drivers

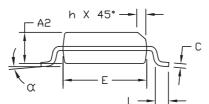
#### Package Information (continued)

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to www.maxim-ic.com/packages.)



	INCH	ES	MILLIMETERS		
DIM	MIN	MAX	MIN	MAX	
Α	.061	.068	1.55	1.73	
A1	.004	.0098	0.102	0.249	
A2	.055	.061	1.40	1.55	
В	.008	.012	0.20	0.30	
С	C .0075 .0098 0.191		0.191	0.249	
D		SEE VA	RIATIONS		
Ε	.150	.157	3.81 3.99		
е	.025	BSC	0.635	BSC	
Н	.230	.244	5.84	6.20	
h	.010	.016	0.25	0.41	
L	.016	.035	0.41	0.89	
N		SEE VA	RIATION	2	
α	0*	8*	0*	8*	





VARIAT	:SNDI
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	INCHE	INCHES MILLIMETERS						
	MIN.	MAX.	MIN.	MAX.	N			
D	.189	.196	4.80	4.98	16	ΑВ		
S	.0020	.0070	0.05	0.18				
D	.337	.344	8.56	8.74	20	ΑD		
S	.0500	.0550	1.270	1.397				
D	.337	.344	8.56	8.74	24	ΑE		
S	.0250	.0300	0.635	0.762				
D	.386	.393	9.80	9.98	28	ΑF		
S	.0250	.0300	0.635	0.762				

#### NOTES:

- 1). D & E DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS.
  2). MOLD FLASH OR PROTRUSIONS NOT TO EXCEED .006" PER SIDE.
  3). CONTROLLING DIMENSIONS: INCHES.
  4). MEETS JEDEC MO137.

	DALLAS / I / IX I / IV REPRIETARY INFORMATION										
TITLE											
PACKAGE OUTL	INE, QSOP .150", .025" LE	AD PITCH									
APPROVAL	DOCUMENT CONTROL NO. 21-0055	E 1/1									

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